

## **AON7424-VB Datasheet** N-Channel 30 V (D-S) MOSFET

Top View

2

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Typ.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
30	0.004 at V <sub>GS</sub> = 4.5 V	60	33.5 nC		
30	0.005 at $V_{GS}$ = 2.5 V	50	33.3110		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $\rm R_g$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

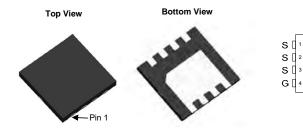
- Motor Control
- Industrial
- Load Switch
- ORing

\* D

7 🛛 D

6 🛛 D

5 D



DFN 3x3 EP

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted) Parameter Symbol Limit Unit Drain-Source Voltage V<sub>DS</sub> 30 V Gate-Source Voltage V<sub>GS</sub> ± 20 T<sub>C</sub> = 25 °C 60<sup>a, e</sup> 40<sup>a, e</sup> T<sub>C</sub> = 70 °C Continuous Drain Current (T<sub>J</sub> = 150 °C) $I_D$ T<sub>A</sub> = 25 °C 22<sup>b, c</sup> 15<sup>b, c</sup> T<sub>Δ</sub> = 70 °C А Pulsed Drain Current (t = 300 µs) I<sub>DM</sub> 150 T<sub>C</sub> = 25 °C 35 Continuous Source-Drain Diode Current $I_S$ 3.3<sup>b, c</sup> T<sub>A</sub> = 25 °C Single Pulse Avalanche Current I<sub>AS</sub> 20 L = 0.1 mHSingle Pulse Avalanche Energy E<sub>AS</sub> mJ 20 T<sub>C</sub> = 25 °C 52 T<sub>C</sub> = 70 °C 33 $P_D$ W Maximum Power Dissipation T<sub>A</sub> = 25 °C 3.7<sup>b, c</sup> T<sub>A</sub> = 70 °C 2.4<sup>b, c</sup> T<sub>J</sub>, T<sub>stg</sub> **Operating Junction and Storage Temperature Range** - 55 to 150 °C Soldering Recommendations (Peak Temperature) 260

#### **THERMAL RESISTANCE RATINGS**

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	24	33	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.9	2.4	0/11

Notes:

a. Based on T<sub>C</sub> = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W.

e. Calculated based on maximum junction temperature. Package limitation current is 80 A.



COMPLIANT

N-Channel MOSFET

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		30		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.5		1.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current	la sa	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А
Drain Source On State Registered	Passa	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.0040		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.0050		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		65		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			6000		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		406		
Reverse Transfer Capacitance	C <sub>rss</sub>			360		
Tatal Cata Charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		68	102	nC
Total Gate Charge	Q <sub>g</sub>			33.5	51	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 10 A		7.7		
Gate-Drain Charge	Q <sub>gd</sub>			13.8		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.7	1.4	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			24	45	- ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		24	45	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 10 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		32	60	
Fall Time	t <sub>f</sub>			12	24	
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		13	26	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 10 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		33	60	
Fall Time	t <sub>f</sub>			8	16	
Drain-Source Body Diode Characteristi	cs			•		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C		35		A
Pulse Diode Forward Current	I <sub>SM</sub>			70		
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 3 \text{ A}, V_{GS} = 0 \text{ V}$		0.7	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21	40	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			10	20	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^{\circ}\text{C}$		9		
Reverse Recovery Rise Time	t <sub>b</sub>			12		ns

Notes:

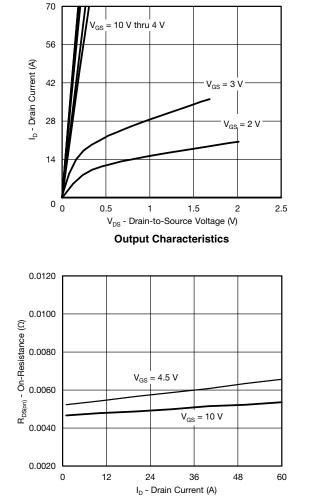
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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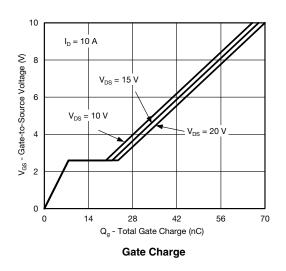
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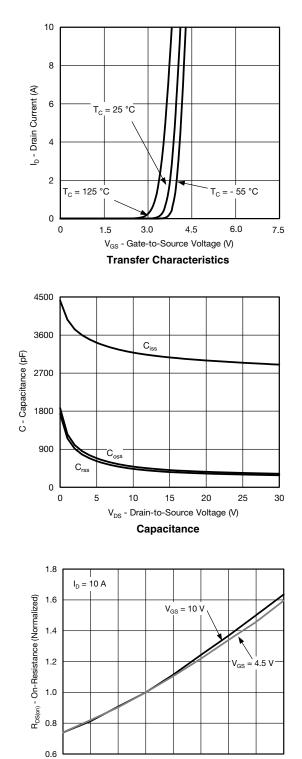




#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

**On-Resistance vs. Drain Current and Gate Voltage** 





T<sub>J</sub> - Junction Temperature (°C) On-Resistance vs. Junction Temperature

50

75

100

125 150

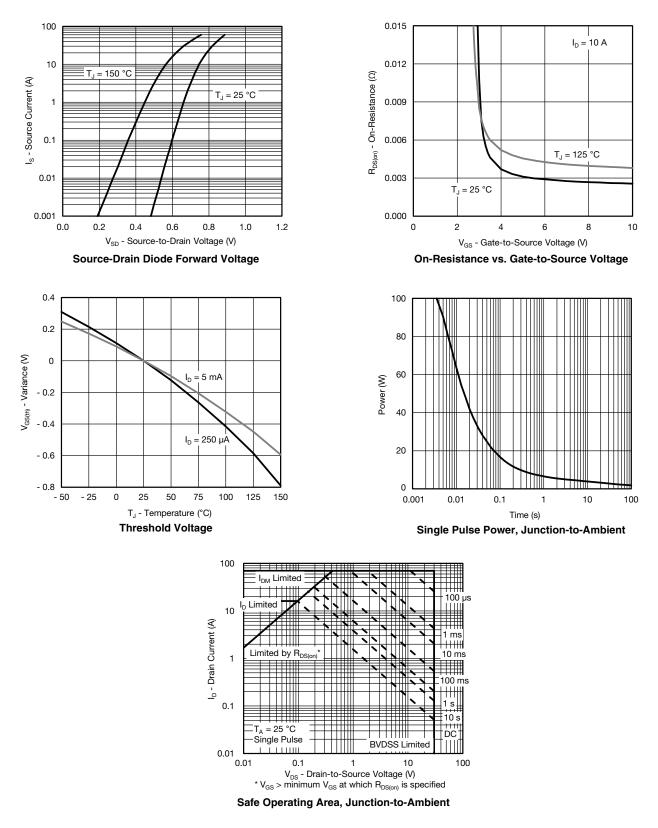
25

0

- 50 - 25

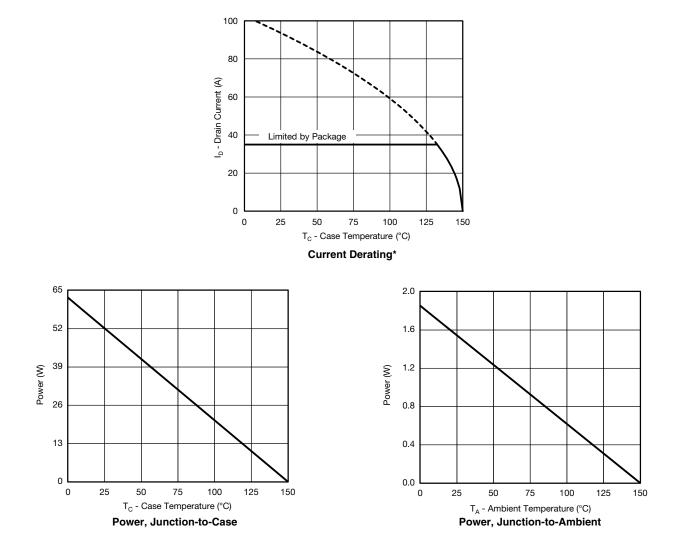








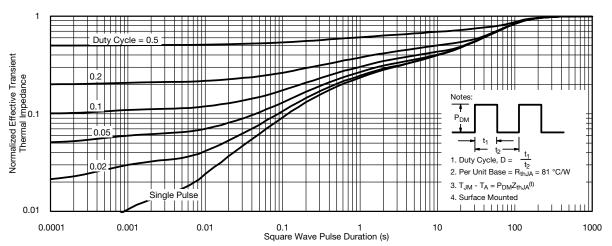
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



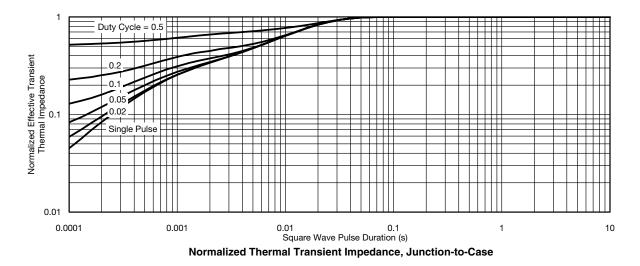
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



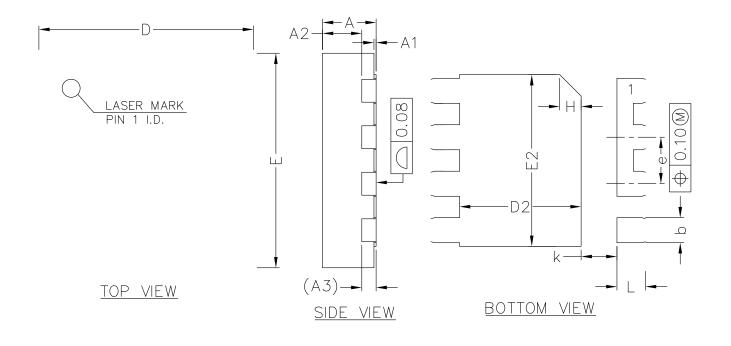
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



B<sup>®</sup>VBsemi www.VBsemi.com





<u>SIDE VIEW</u>

SYMBOL	MIN	NOM	MAX
А	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.50	0.55	0.60
A3	0.20REF		
b	0.30	0.35	0.40
D	2.90	3.00	3.10
E	2.90	3.00	3.10
D2	1.60	1.70	1.80
E2	2.30	2.40	2.50
е	0.55	0.65	0.75
K	0.40	0.50	0.60
	0.35	0.40	0.45

### COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)



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